# Non-Traditional Manufacturing Processes (NTMP)

## Lecture 5 and 6: Electron Beam Machining

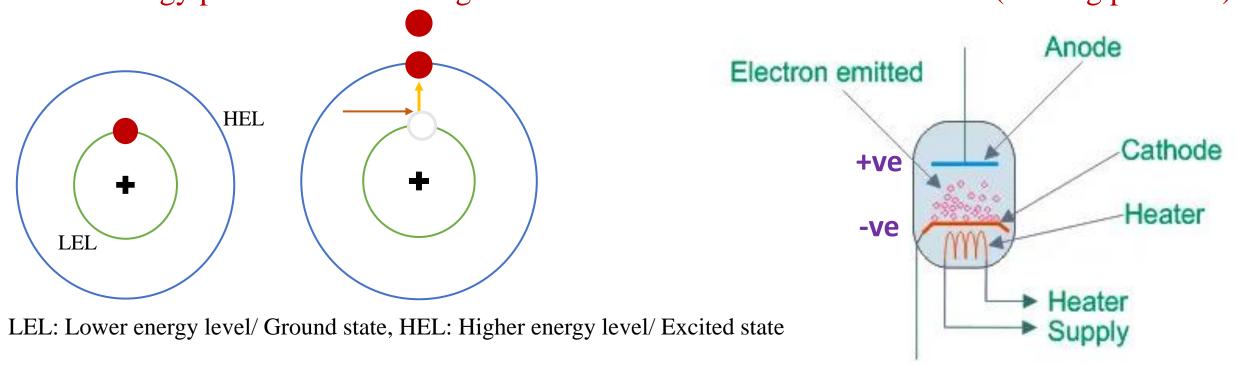


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## **Electron Beam Machining (EBM)**

- Electron beam is used for machining.
- Electrons are generated by thermionic emission from hot tungsten cathode.
- Thermionic emission: emission of electrons from an electrode due to its temperature.

thermal energy provided to the charge carrier > work function of the material (binding potential).



: electron, — → : Thermal energy,

Fig. Schematic of thermionic emission process

## **Electron Beam Machining (EBM)**

• Electron Beam Machining (Drilling) was first introduced in 1952 and EBW was introduced in industry in 1959.

- Spot diameter: 10- 200  $\mu$ m and Power density = 6500 billion W/mm<sup>2</sup> = 6.5 × 10<sup>12</sup> W/mm<sup>2</sup>
- Any material can rapidly melt and vaporize.
- EBM is a very precise vaporization process.
- Basic Process: EBM Thermal process, similar to LBM.
- Material-heating: Striking of high-velocity electrons with workpiece.
- Kinetic energy of electrons → Heat → Rapid melting and vaporizing

## **Electron Beam Machining (EBM)**

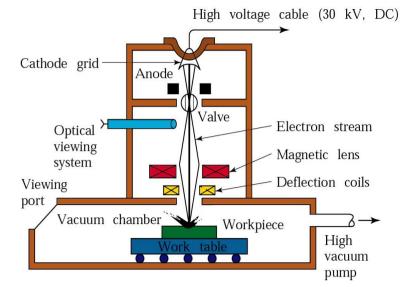
• Applications: Drilling fine holes, cutting narrow slots, welding, annealing, milling, and rapid manufacturing by controlling various operating parameters

• Electron beam processing: Usually done in vacuum unlike LBM.

In atmosphere: Frequent collisions with air molecules

Lateral dispersion due to Scattering, Energy loss,

Reduction in Power density at the work piece.



High Power with High Accelerating Voltage E-Beam – Used in normal Atmosphere

## **Mechanism of Electron Beam Machining (EBM)**

Change in Kinetic Energy of Electron =  $m_e(u - u_o)^2/2$  eV,  $u (km/s) \sim 600 \sqrt{(V)}$   $m_e = 9.1 \times 10^{-31} \text{kg}$ ,  $e = 1.6 \times 10^{-19}$  Coulomb. KE is dissipated in the impinging material.

- \* Unaffected zone: Transparent layer
- \* Energy of Electrons Lattice of material through collisions.
- \* Energy transfer Function of kinetic energy or accelerating voltage.
- Maximum rise in temperature- At a certain depth, not at the surface, unlike laser heating.

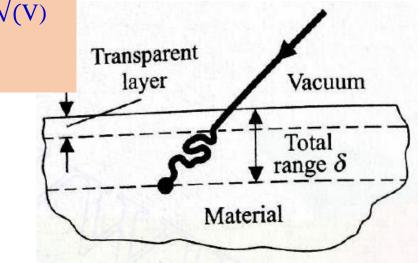


Figure: Movement of an electron below surface

#### **Depth of penetration:**

 $\delta = 2.6 \text{ x} 10^{-17} (\text{V}^2/\rho) \text{ mm}$ 

where,

V=Accelerating voltage (Volts) and

 $\rho = Material density (kg/mm^3)$ 

#### Power requirement for machining:

P = CQ

where,

C = Constant of proportionality or specific power consumption in

EBM, and Q = Material removal rate

#### **Numerical**

Q. What will be the penetration depth of the electron beam accelerated at 150 kV impinging in steel having density of  $76 \times 10^{-7}$  kg/mm<sup>3</sup>?

$$\delta = 2.6 \text{ x} 10^{-17} (\text{V}^2/\rho) \text{ mm}$$

$$\delta = 77 \, \mu m$$

Q. An electron beam of 5 kW power is used for cutting a 150  $\mu$ m wide slot in 1 mm thick tungsten sheet. Determine the cutting speed?

(Specific power consumption in EBM (constant of proportionality) for tungsten is 12 W/mm³/min)

**Solution:** 

$$P = CQ$$

Let the speed of cutting be V mm/min.

$$Q = AV = 150 \times 10^{-3} \times 1 \times V \text{ mm}^{3}/\text{min}$$

$$P = C_{Tungusten} Q$$

$$5000 = 12 \times 150 \times 10^{-3} \times 1 \times V$$

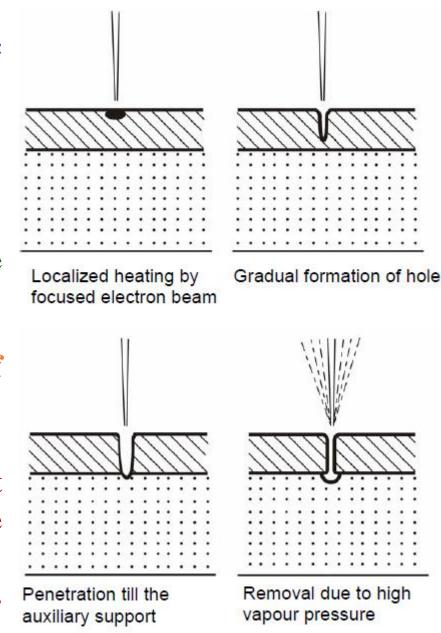
$$V = 2778 \text{ mm/min} = 4.6 \text{ cm/sec}$$

## **Electron Beam Drilling Process: Four Stages**

- 1. Localized heating of work-piece: On an organic or synthetic backing
- \* E-beam focal spot diameter ≤ Desired diameter
- \* Power density: ~108 W/cm<sup>2</sup>, sufficient to melt & vaporize any material.

#### 2. Vaporization of a small fraction of melted material

- Recoil pressure of escaping vapour pushes the molten material aside creating a hole.
- 3. E-beam penetrates in till it reaches the bottom surface of work piece.
- 4. **Removal of material:** As e-beam strikes the auxiliary support volume in contact is totally vaporized resulting in the explosive release of backing material vapour
- \* High velocity vapour carries along with it the molten walls of the capillary, creating a hole in the work piece and a small cavity in the backing material.



## **Components of Electron Beam Machining**

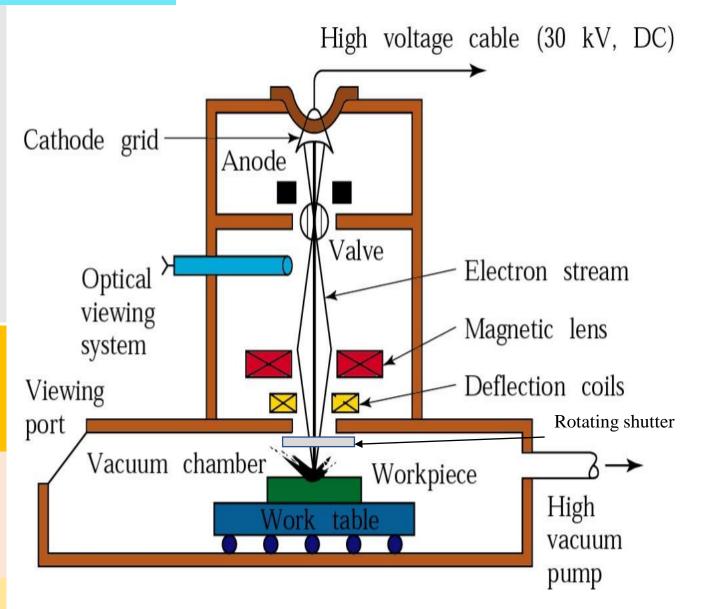
**Electron beam gun:** Electrons are generated by thermionic emission from hot tungsten cathode.

In E-beam gun for cutting & drilling applications, there is a grid between anode & cathode on which negative voltage is applied to pulse / modulate the e-beam.

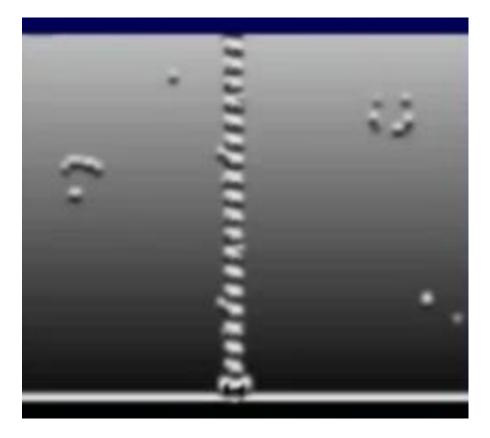
**Power supply:** Up to 150 kV, Current :  $150 \mu A-1.5A$ .

**Vacuum-chamber**: 10<sup>-4</sup>-10<sup>-6</sup> Torr (1 Torr = 1 mm Hg) achieved by rotary pump backed diffusion pump.

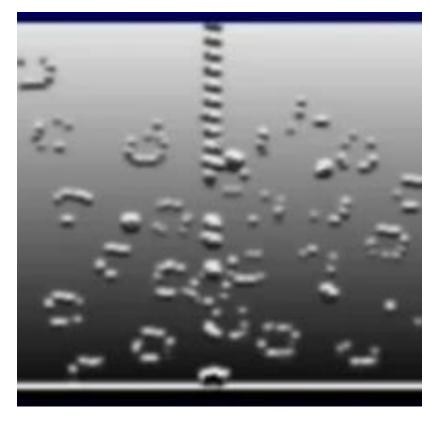
Vacuum compatible CNC workstation



## Requirement of Vacuum in EBM



Electron beam in vacuum



Electron beam in ambient air

## **Diffusion Pump**

- Diffusion pump is essentially an oil heater.
- As the oil is heated the oil vapour rushes upward. The nozzles change the direction of motion of the oil vapour and the oil vapour starts moving downward at a high velocity as jet.
- Such high velocity jets of oil vapour traps any air molecules present within the gun through diffusion.
- The oil vapour condenses due to presence of cooling water jacket around the diffusion pump. Redirected back to the boiler and recycled.
- Builds high pressure at the bottom and low pressure at the top.

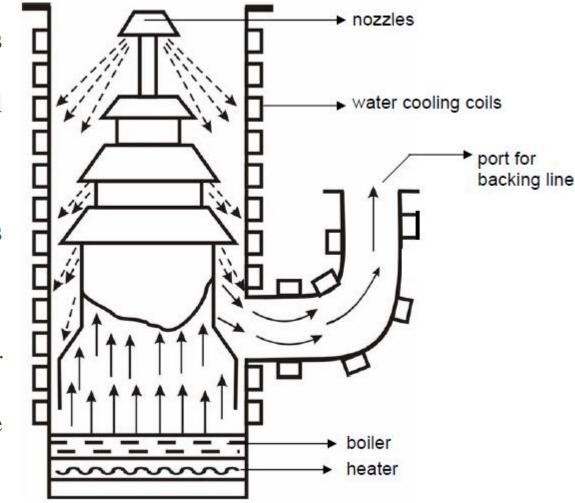


Fig. Working of a diffusion pump

#### **Current Control in EBM**

• Hot cathode emits electrons under vacuumed condition, and the thermionic emission is given by the Richardson- Dushman equation:

$$j = A T^2 \exp(-eW/kT)$$

Nobel prize in physics in 1928

where,

j = Emission current density (amp/cm<sup>2</sup>) from the cathode surface

W = Work function of the cathode material (Volts)

T = Absolute Temperature of cathode (K)

e = Electron charge (Coulomb)

 $k = Boltzmann constant (1.3 x 10^{-23} J/K)$ 

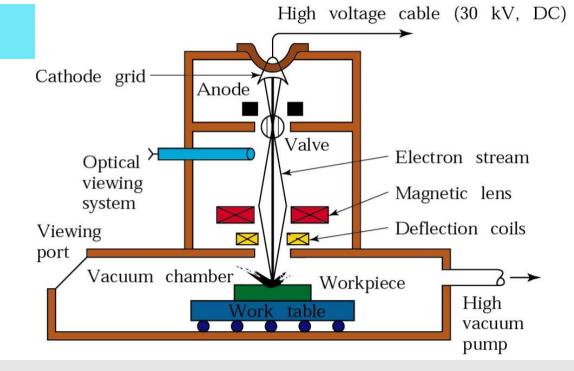
 $A = Constant (\sim 120 Amp/cm^2.K^2)$ 

• Cathode Material: Tungsten or thoriated tungsten

#### **Process Parameters of EBM**

The process parameters, which directly affect the machining characteristics in EBM are:

- Accelerating Voltage
- E-Beam Current
- Pulse duration
- Energy per pulse
- Peak power
- Lens used- determines the focusing & focal length
- Spot size
- Beam deflection signal
- Beam power density
- Vacuum level in the machine



#### Typical Process Parameters:

Electron Acceleration Voltage: 10-150 kV

Electron beam current :  $100 \mu A - 1.5A$ 

Electron beam Power delivered

(Accelerating Voltage x Beam Current): 30 W-100 kW

Process Medium / Environment : Vacuum, 10<sup>-4</sup>-10<sup>-6</sup> Torr

(mm of Hg)

Beam Energy is increased preferably by increasing current than accelerating voltage to avoid more scattering at higher electron energy.

## **Energy Balance in EBM**

#### Energy balancing:

(mass flow rate ( $\dot{m}$ ) = density \* area \* velocity)

$$\eta P = \dot{m} (C_p \Delta T)$$

$$\eta P = w.t.v.\rho.C_p.\Delta T$$

w= kerf width  $\approx$  Thermal diffusion length  $\approx 2\sqrt{\alpha\tau} = 2\sqrt{\alpha d/v}$ 

Where,  $\eta = E$ - beam power coupling efficiency including conduction loss  $\approx 0.1$ ,

P = E-beam power in W;

t= depth of penetration in m up to which rise in temperature is  $\Delta T$ ,

 $\alpha$  = Thermal diffusivity = k/  $\rho$ .  $C_p$ 

k= Thermal conductivity of material in W/m.°C

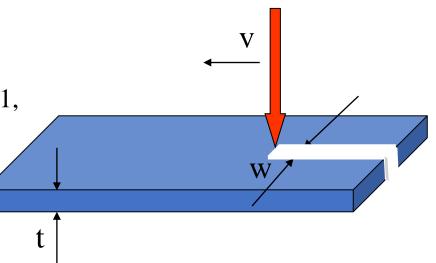
 $\rho$  =Material density in g/m<sup>3</sup>;  $C_p$  = Specific heat in J/kg. °C;

 $\tau$  = E-beam material interaction time

(For continuous e-beam scanned at velocity, v interaction time,  $\tau = d/v$ )

d= width of e-beam in m;

v= Processing speed in m/s



#### **Numerical**

Q: In a 1 mm tungsten sheet a 200 micron wide slot is to be cut using a 4kW electron beam. Estimate the maximum cutting speed.

$$\rho = 19300 \text{ kg/m}^3$$
,  $C_p = 140 \text{ J/kg °C}$ ,  $L_f = 185 \text{ kJ/kg}$   
 $L_v = 4020 \text{ kJ/kg}$ ,  $\alpha = 164 \text{W/m°C}$ ,  $T_v = 5930 \text{ °C}$ ,  $\eta = 0.1$ 

#### **Solution:**

w=200 micron, t=1mm, P=4kW,

$$w = 2\sqrt{\alpha d/v}$$
 ----(1)

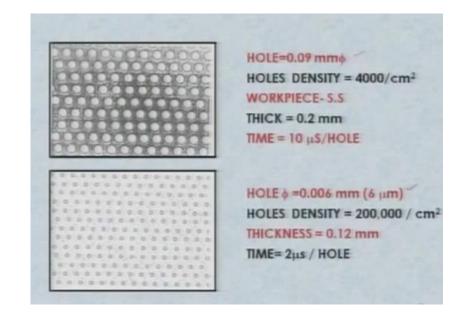
$$\eta P = \text{w.t.v.} \rho.C_p$$
,  $\Delta T$ -----(2)

We need to solve for d & v

## **Applications of EBM**

**EB Drilling**: Suitable where large no. of holes are needed and drilling holes with conventional process is difficult due to material hardness or hole-geometry.

- Used in aerospace, instrumentation, food, chemical & textile industries.
- Thousands of tiny holes in Turbine (steel) engine combustor.
- Cobalt alloy fiber spinning heads.
- Filters used in food processing.
- Perforation in artificial leather to make shoes for air-breathing:
  0.12 mm hole made at 5000/s.





Insulation
Centrifugal disc for glass
wool production
12000 to 45000 holes
https://www.pro-



Sieves for food industry 12 million holes /m<sup>2</sup> 1805 holes/sec

beam.com/en/contractmanufacturing/mikrobohren

## **Process Capabilities**

- A wide range of materials, such as stainless steel, Cu, Al, Ni and cobalt alloys, super alloy, titanium, tungsten, ceramic, leather and plastic.
- Cutting up to a thickness of 10 mm: material removal by vaporization
- Hole-diameter ranging from 0.1- 1.4 mm and thickness up to 10 mm. High aspect (depth to diameter) 15:1
- Holes at angle ranging from 20° -90°
- No much force to the work-piece, thereby allowing brittle and fragile materials to be processed without danger of fracturing.
- Hole diameter accuracy  $\pm 0.02$  mm in thin sheets

## **Advantages of EBM**

#### **Drilling & Cutting**

- Any material can be machined
- No cutting forces are involved so no stresses imposed on part
- Exceptional drilling speeds possible with high position accuracy
- Extremely small kerf width, less wastage of material
- Less mechanical or thermal distortion
- Computer-controlled parameters
- High aspect ratio
- High accuracy

#### **Limitations of EBM**

- ➤ High capital cost and maintenance cost
- ➤ Non-productive pump down time
- > Recast at the edges
- > High level of operator skill required
- ➤ Maximum thickness in cutting (~ 10 mm)
- ➤ A suitable backing material must be used
- Ferrous material to be demagnetized as otherwise could affect the e-beam
- ➤ Work area must be under a vacuum Size restriction

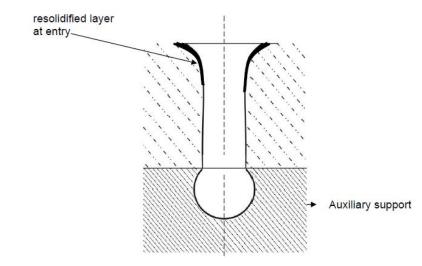


Fig. Typical kerf shape of electron beam drilled hole

## **Summary of EBM**

Mechanics of material removal	Melting, Vaporization
Medium	Vacuum ( 10 <sup>-4</sup> -10 <sup>-6</sup> Torr),
	Air with high power, high voltage beam (not yet commercialized)
Tool	High velocity electron beam
Maximum material removal rate	~ 50 mm <sup>3</sup> /min
Specific power consumption	450 W/mm <sup>3</sup> -min
Critical Parameters	Accelerating voltage, beam current, beam diameter, work speed, melting
	temperature
Material applications	All materials
Shape applications	Drilling fine holes, contour cutting, cutting narrow slots
Limitations	High specific energy, Necessity of vacuum, Very high machine cost.

# THANK YOU?